

Developing a “Digital Twin” for Area-Selective Deposition on 3D Nanopatterns

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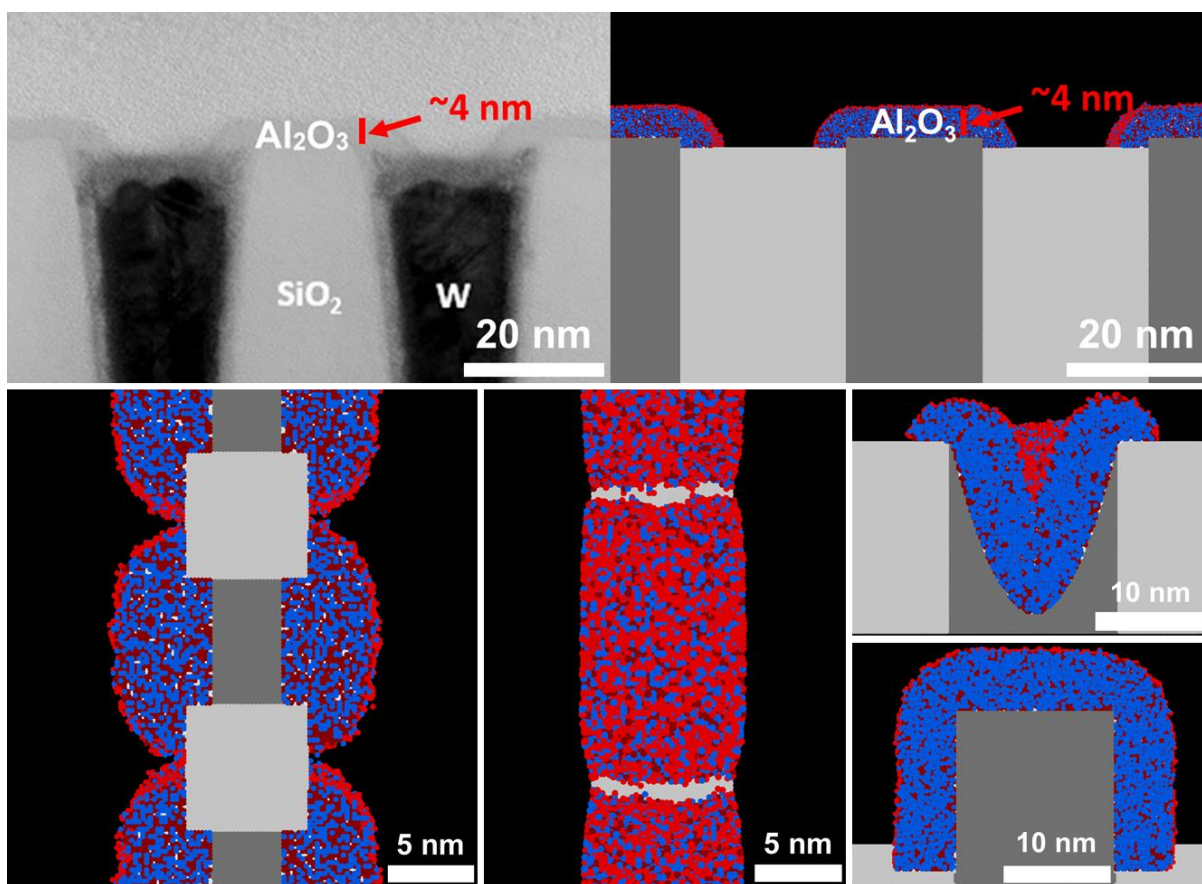
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Area-selective deposition (ASD)—a bottom-up patterning technique that enables precise material deposition on specific regions while preventing deposition elsewhere—has garnered significant attention as an augmentation to lithographic patterning of nanoscale features during semiconductor manufacturing. Some potential applications, such as contact-over-active-gate, will require multiple ASD materials to be deposited in sequence, heightening the challenge of effective process design. Given the vast time and resources required for experimental assessments of process integration, demand is rapidly growing for a “digital twin” (i.e. a software representation of a physical system) of device fabrication sequences. A comprehensive ASD digital twin will require advances in analyzing atomic layer deposition (ALD) reactor design and mechanistic insights into interactions between inhibitor molecules, ALD reactants, and substrate surfaces over time as reactions proceed.

We have recently developed a stochastic lattice model describing metal oxide ASD on planar substrates, including means to visualize the film shape and extent of lateral overgrowth during ASD.^[1] Parameters in the model can be adjusted based on steric hinderance during each half-cycle, differences in interfacial energies between the non-growth surface and the growing film, and the preferred molecular bonding orientations. These factors elucidate subtleties in shape evolution during ASD, but results to date have been limited to vertical and lateral growth on 2D surfaces. A functional ASD digital twin must describe ASD on arbitrary 3D nanopatterns and on sub-lithographic feature sizes, including effects of selectivity loss where the selectivity decreases as film thickness increases.

We will present recent efforts in our group to extend the functionality of the stochastic lattice model to describe ASD on 3D substrates, including surfaces with pattern dimensions less than 10 nm. On very small features, for example, the model shows that lateral growth during ASD results in a wide distribution of feature separation distances, even when the growth per cycle is uniform across a growing film surface. We will also discuss intricacies that need to be considered to integrate multiple ASD steps into processes involving more complex “multi-color” substrates where several substrate materials exposed to reactants simultaneously. We believe that such insight will be critical for the realization of a functional digital twin model of atomic-scale processing needed for future semiconductor devices and other advanced manufacturing processes.

(1) Carroll, N. M.; Parsons, G. N. *J. Vac. Sci. Technol. A* **42** (6), 062411 (2024).



Example results of ASD modeled on 3D nanopatterns, including structures with sub-lithographic feature sizes. Shape evolution on 3D structures is vital to understand expected stochastics and performance of future structures formed by ASD. Top-left image adapted with permission from Huang, J. et al. *ACS Appl. Mater. Interfaces* **15** (21), 26128 (2023). Copyright 2023 the American Chemical Society.